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# RENESAS HD74LVC374A

# Octal D-type Flip Flops with 3-state Outputs

REJ03D0355-0400Z (Previous ADE-205-113B (Z)) Rev.4.00 Jul. 27, 2004

### Description

The HD74 LVC374A has eight edge trigger D type flip flops with three state outputs in a 20 pin package. Data at the D inputs meeting set up requirements are transferred to the Q outputs on positive going transitions of the clock input. When the clock input goes low, data at the D inputs will be retained at the outputs until clock input returns high again. When a high logic level is applied to the output control input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements. Low voltage and high-speed operation is suitable at the battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

### Features

- $V_{CC} = 2.0 \text{ V to } 5.5 \text{ V}$
- All inputs  $V_{IH}$  (Max.) = 5.5 V (@V<sub>CC</sub> = 0 V to 5.5 V)
- All outputs  $V_{OUT}$  (Max.) = 5.5 V (@V<sub>CC</sub> = 0 V or output off state)
- Typical  $V_{OL}$  ground bounce < 0.8 V (@V<sub>CC</sub> = 3.3 V, Ta = 25 °C)
- Typical  $V_{OH}$  undershoot > 2.0 V (@V<sub>CC</sub> = 3.3 V, Ta = 25°C)
- High output current  $\pm 24 \text{ mA} (@V_{CC} = 3.0 \text{ V to } 5.5 \text{ V})$
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LVC374AFPEL	SOP-20 pin (JEITA)	FP-20DAV	FP	EL (2,000 pcs/reel)
HD74LVC374ATELL	TSSOP-20 pin	TTP-20DAV	Т	ELL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

### **Function Table**

Inputs

G	СК	D	Output Q	
Н	Х	Х	Z	
L	↑	L	L	
L	↑	Н	Н	
L	L	X	Q <sub>0</sub>	

H: High level

L: Low level

X: Immaterial

Z: High impedance

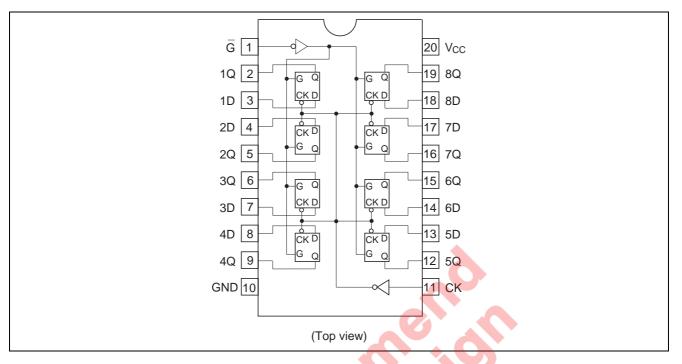
 $\uparrow$ : Low to high transition

Q<sub>0</sub>: Level of Q before the indicated steady input conditions were established.



#### HD74LVC374A

### **Pin Arrangement**



## **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CC</sub>	-0.5 to 6.0	V	
Input diode current	I <sub>IK</sub>	-50	mA	$V_{I} = -0.5 V$
Input voltage	VI	-0.5 to 6.0	V	
Output diode current	I <sub>OK</sub>	-50	mA	V <sub>O</sub> = -0.5 V
		50		$V_{\rm O} = V_{\rm CC} + 0.5 \ V$
Output voltage	Vo	-0.5 to V <sub>CC</sub> +0.5	V	Output "H" or "L"
	0	-0.5 to 6.0		Output "Z" or V <sub>CC</sub> :OFF
Output current	lo	±50	mA	
V <sub>CC</sub> , GND current / pin	I <sub>CC</sub> or I <sub>GND</sub>	100	mA	
Storage temperature	Tstg	-65 to +150	°C	

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

## **Recommended Operating Conditions**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	Vcc	1.5 to 5.5	V	Data hold
		2.0 to 5.5		At operation
Input / output voltage	VI	0 to 5.5	V	G, CK, D
	Vo	0 to V <sub>CC</sub>	V	Output "H" or "L"
		0 to 5.5		Output "Z" or V <sub>CC</sub> :OFF
Operating temperature	Та	-40 to 85	°C	
Output current	I <sub>ОН</sub>	–12	mA	$V_{CC} = 2.7 V$
		-24 <sup>*2</sup>		$V_{CC}$ = 3.0 V to 5.5 V
	I <sub>OL</sub>	12	mA	$V_{CC} = 2.7 V$
		24 <sup>*2</sup>		$V_{CC} = 3.0 \text{ V} \text{ to } 5.5 \text{ V}$
Input rise / fall time *1	t <sub>r</sub> , t <sub>f</sub>	10	ns/V	

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

2. Duty cycle  $\leq 50\%$ 

### **Electrical Characteristics**

			Ta = -4	0 to 85°C		
Item	Symbol	V <sub>cc</sub> (V)	Min	Max	Unit	Test Conditions
Input voltage	VIH	2.7 to 3.6	2.0	-	V	
		4.5 to 5.5	V <sub>cc</sub> ×0.7	_		
	VIL	2.7 to 3.6	-	0.8	V	
		4.5 to 5.5		V <sub>cc</sub> ×0.3		
Output voltage	V <sub>OH</sub>	2.7 to 5.5	V <sub>cc</sub> –0.2		V	I <sub>OH</sub> = −100 μA
		2.7	2.2	—		I <sub>OH</sub> = -12 mA
		3.0	2.4	_		
		3.0	2.2	_		I <sub>OH</sub> = -24 mA
		4.5	3.8	_		
	V <sub>OL</sub>	2.7 to 5.5	_	0.2	V	I <sub>OL</sub> = 100 μA
		2.7		0.4		I <sub>OL</sub> = 12 mA
		3.0		0.55	_	I <sub>OL</sub> = 24 mA
	<u> </u>	4.5	_	0.55		
Input current	I <sub>IN</sub>	0 to 5.5	_	±5.0	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Off state output current	I <sub>OZ</sub>	2.7 to 5.5	—	±5.0	μΑ	$V_{IN} = V_{CC}, GND$
						$V_{OUT} = 5.5 V \text{ or GND}$
Output leak current	I <sub>OFF</sub>	0	_	20	μΑ	$V_{IN} / V_{OUT} = 5.5 V$
Quiescent supply current	I <sub>CC</sub>	2.7 to 3.6		±10	μΑ	$V_{IN} / V_{OUT} = 3.6 \text{ to } 5.5 \text{ V}$
		2.7 to 5.5	_	10		$V_{IN} = V_{CC}$ or GND
	$\Delta I_{CC}$	3.0 to 3.6	_	500	μΑ	$V_{IN}$ = one input at( $V_{CC}$ -0.6)V,
						other inputs at $V_{CC}$ or GND

## **Switching Characteristics**

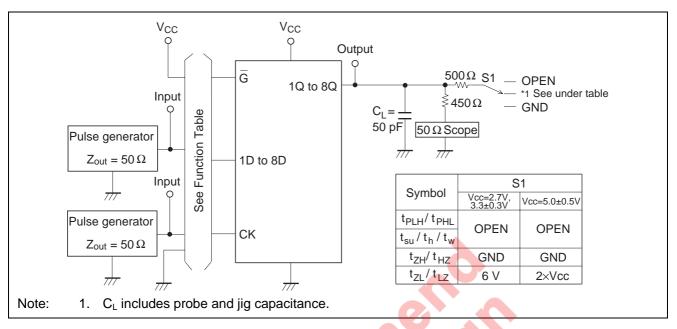
			Ta = −40 to 85°C				From	То
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Unit	(Input)	(Output)
Maximum clock	f <sub>max</sub>	2.7	80.0	_	_	MHz		
frequency		3.3±0.3	100.0	150.0	_			
		5.0±0.5	125.0		_			
Propagation delay time	t <sub>PLH</sub>	2.7	_	_	9.5	ns	СК	Q
	t <sub>PHL</sub>	3.3±0.3	1.5	_	8.5			
		5.0±0.5		_	7.0			
Output enable time	t <sub>ZH</sub>	2.7			9.5	ns	G	Q
	t <sub>ZL</sub>	3.3±0.3	1.5	_	8.5			
		5.0±0.5		_	7.0			
Output disable time	t <sub>HZ</sub>	2.7			8.5	ns	G	Q
	t <sub>LZ</sub>	3.3±0.3	1.5	_	7.5			
		5.0±0.5		_	6.5			
Setup time	t <sub>su</sub>	2.7	2.0	_	_	ns		
		3.3±0.3	2.0	_	-			
		5.0±0.5	2.0	_	-			
Hold time	t <sub>h</sub>	2.7	1.5	—	4	ns		
		3.3±0.3	1.5	-	—			
		5.0±0.5	1.5		—			
Pulse width	t <sub>w</sub>	2.7	3.3			ns		
		3.3±0.3	3.3 🔨		2			
		5.0±0.5	3.3	-	4			
Between output pins skew	<sup>1</sup> t <sub>OSLH</sub>	2.7		—	—	ns		
	t <sub>OSHL</sub>	3.3±0.3	4	-	1.0			
		5.0±0.5	-	-	1.0			
Input capacitance	CIN	2.7	-	3.0	_	pF		
Output capacitance	Co	2.7	-96	15.0		pF		

Note: 1. This parameter is characterized but not tested.

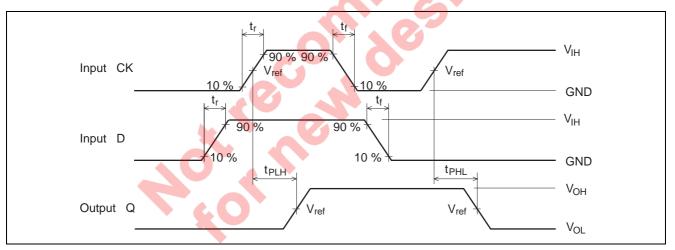
 $tos_{LH} = |t_{PLHm} - t_{PLHn}|, tos_{HL} = |t_{PHLm} - t_{PHLn}|$ 

#### HD74LVC374A

### **Test Circuit**



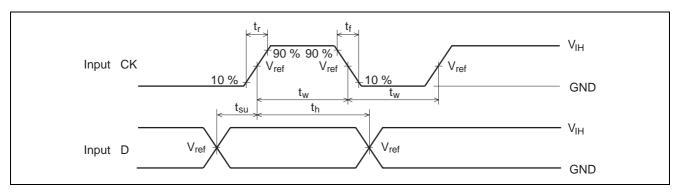
#### Waveforms - 1



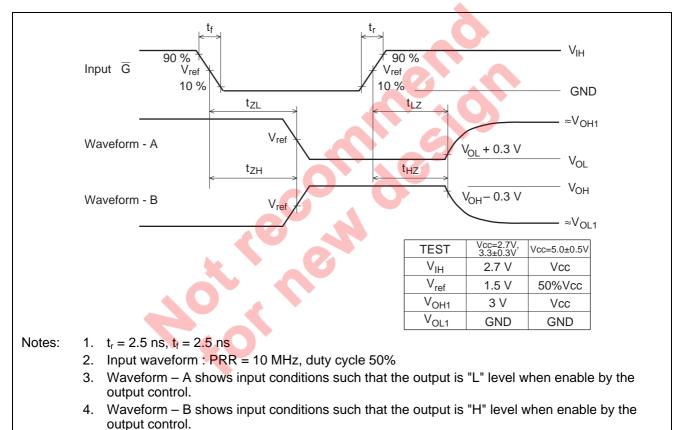


#### HD74LVC374A

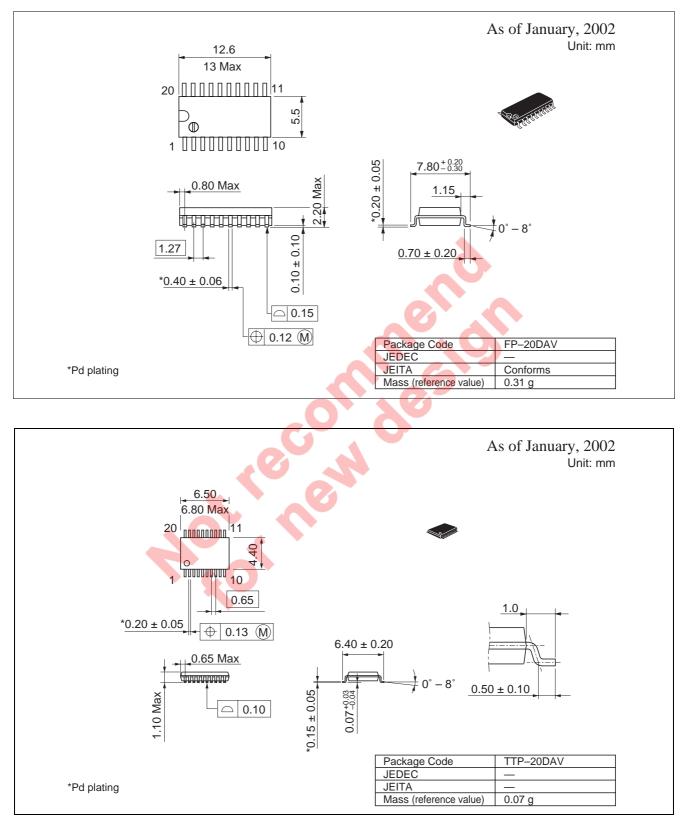
#### Waveforms - 2



#### Waveforms - 3



### **Package Dimensions**





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